**PRODUCT FEATURES**

- Integrated USB 2.0 Compatible 2-Port Hub
  - High-Speed (480Mbits/s), Full-Speed (12Mbits/s) and Low-Speed (1.5Mbits/s) compatible
  - Full power management with ganged power control
  - Detects Bus-Power/Self-Power source and changes mode automatically
- Complete USB Specification 2.0 Compatibility
  - Includes USB 2.0 Transceivers
- VID/PID/DID, and Port Configuration for Hub via:
  - Single Serial I²C EEPROM
  - SMBus Slave Port
- Default VID/PID/DID, allows functionality when configuration EEPROM is absent
- Hardware Strapping options allow for configuration without an external EEPROM or SMBus Host
- On-Board 24MHz Crystal Driver Circuit or 24 MHz external clock driver
- Internal PLL for 480MHz USB 2.0 Sampling
- Internal 1.8V Linear Voltage Regulator
- Integrated USB termination and Pull-up/Pull-down resistors
- Internal Short Circuit protection of USB differential signal pins
- Basic single-color LED support
- 1.8 Volt Low Power Core Operation
- 3.3 Volt I/O with 5V Input Tolerance
- 36 Pin QFN or 48 Pin TQFP lead-free RoHS compliant package
ORDER NUMBERS:
USB2502-AEZG FOR 36 PIN LEAD-FREE ROHS COMPLIANT QFN PACKAGE; USB2502-HT FOR 48 PIN LEAD-FREE ROHS COMPLIANT TQFP PACKAGE

80 ARKAY DRIVE, HAUPPAUGE, NY 11788 (631) 435-6000, FAX (631) 273-3123

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General Description

The SMSC 2-Port Hub is fully compliant with the USB 2.0 Specification and will attach to a USB host as a Full-Speed Hub or as a Full-/High-Speed Hub. The 2-Port Hub supports Low-Speed, Full-Speed, and High-Speed (if operating as a High-Speed Hub) downstream devices on all of the enabled downstream ports.

The Hub works with an external USB power distribution switch device to control $V_{BUS}$ switching to downstream ports, and to limit current and sense over-current conditions.

All required resistors on the USB ports are integrated into the Hub. This includes all series termination resistors on D+ and D− pins and all required pull-down and pull-up resistors on D+ and D− pins. The over-current sense inputs for the downstream facing ports have internal pull-up resistors.

Throughout this document the upstream facing port of the hub will be referred to as the upstream port, and the downstream facing ports will be called the downstream ports.

OEM Selectable Features

A default configuration is available in the USB2502 following a reset. This configuration may be sufficient for some applications. Strapping option pins make it possible to modify a limited sub-set of the configuration options.

The USB2502 may also be configured by an external EEPROM or a microcontroller. When using the microcontroller interface, the Hub appears as an SMBus slave device. If the Hub is pin-strapped for external EEPROM configuration but no external EEPROM is present, then a value of ‘0’ will be written to all configuration data bit fields (the hub will attach to the host with all ‘0’ values).

The 2-Port Hub supports several OEM selectable features:

- Operation as a Self-Powered USB Hub or as a Bus-Powered USB Hub.
- Operation as a Dynamic-Powered Hub (Hub operates as a Bus-Powered device if a local power source is not available and switches to Self-Powered operation when a local power source is available).
- Optional OEM configuration via I2C EEPROM or via the industry standard SMBus interface from an external SMBus Host.
- Compound device support (port is permanently hardwired to a downstream USB peripheral device).
- Hardware strapping options enable configuration of the following features.
  - Non-Removable Ports
  - Port Power Polarity (active high or active low logic)
Figure 1 2-Port Block Diagram
Package Outlines

Figure 2 36 Pin QFN Package

NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETER.
2. POSITION TOLERANCE OF EACH TERMINAL IS ± 0.05MM AT MAXIMUM MATERIAL CONDITION. DIMENSIONS "L" APPLIES TO PLATED TERMINALS AND IT IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
3. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE AREA INDICATED.
4. COPLANARITY ZONE APPLIES TO EXPOSED PAD AND TERMINALS.
Figure 3 48 Pin TQFP Package Outline (7x7x1.4 mm body, 2mm Footprint)

Table 1 48 Pin TQFP Package

<table>
<thead>
<tr>
<th>MIN</th>
<th>NOMINAL</th>
<th>MAX</th>
<th>REMARKS</th>
</tr>
</thead>
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<tr>
<td>A</td>
<td>~</td>
<td>1.60</td>
<td>Overall Package Height</td>
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<td>A1</td>
<td>0.05</td>
<td>0.15</td>
<td>Standoff</td>
</tr>
<tr>
<td>A2</td>
<td>1.35</td>
<td>1.45</td>
<td>Body Thickness</td>
</tr>
<tr>
<td>D</td>
<td>8.80</td>
<td>9.20</td>
<td>X Span</td>
</tr>
<tr>
<td>D1</td>
<td>6.90</td>
<td>7.10</td>
<td>X body Size</td>
</tr>
<tr>
<td>E</td>
<td>8.80</td>
<td>9.20</td>
<td>Y Span</td>
</tr>
<tr>
<td>E1</td>
<td>6.90</td>
<td>7.10</td>
<td>Y body Size</td>
</tr>
<tr>
<td>H</td>
<td>0.09</td>
<td>0.20</td>
<td>Lead Frame Thickness</td>
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<tr>
<td>L</td>
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<td>0.75</td>
<td>Lead Foot Length</td>
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<tr>
<td>L1</td>
<td>~</td>
<td>1.00</td>
<td>Lead Length</td>
</tr>
<tr>
<td>e</td>
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<td>~</td>
<td>Lead Pitch</td>
</tr>
<tr>
<td>θ</td>
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<td>7°</td>
<td>Lead Foot Angle</td>
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<tr>
<td>W</td>
<td>0.17</td>
<td>0.27</td>
<td>Lead Width</td>
</tr>
<tr>
<td>R1</td>
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<td>~</td>
<td>Lead Shoulder Radius</td>
</tr>
<tr>
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<td>0.08</td>
<td>0.20</td>
<td>Lead Foot Radius</td>
</tr>
<tr>
<td>ccc</td>
<td>~</td>
<td>0.08</td>
<td>Coplanarity</td>
</tr>
</tbody>
</table>

Notes:
1. Controlling Unit: millimeter.
2. Tolerance on the true position of the leads is ± 0.04 mm maximum.
3. Package body dimensions D1 and E1 do not include the mold protrusion.
   Maximum mold protrusion is 0.25 mm.
4. Dimension for foot length L measured at the gauge plane 0.25 mm above the seating plane.
5. Details of pin 1 identifier are optional but must be located within the zone indicated.